AUG. 30. 2006 2:33PM 919-854-1401 MBS&S

NO. 2534 P. 2

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## ASSIGNMENT RECORDATION FORM COVER SHEET Patents Only

To: Commissioner for Patents:	Date: August 30, 2006
Please record the attached original documents or copy thereof.	Attorney Docket No. 5649-1953
1. Name of conveying party(ies);	2. Name and address of receiving party(ies):
<ul><li>[1.] Seung-ok Jung</li><li>[2.] II-young Moon</li></ul>	Samsung Electronics Co., Ltd. 416 Maetan-dong Yeongtong-gu, Suwon-si Gyeonggi-do, Republic of Korea
Additional name(s) of conveying party(ies) attached? Yes xx No	
3. Nature of conveyance:	
<u>xx</u> Assignment Merger Security Agreement Change of Name Other Execution Date: [1.] 08/20/2006 [2.] 08/20/2006	Additional name(s) & address(es) attached? YesXX_No
4. Application Serial No. <u>11/476,459</u> Patent No.	
If this document is being filed together with a new application, the execution date of the application is: Additional numbers attached? Yes No	
<ul> <li>5. Name and address of party to whom correspondence concerning document should be mailed:</li> <li>Scott C. Hatfield</li> <li>Myers Bigel Sibley &amp; Sajovec</li> <li>P. O. Box 37428</li> <li>Raleigh NC 27627</li> </ul>	<ul> <li>6. Total number of applications and patents involved: 1</li> <li>7. Total fee (37 CFR 3.41) <u>\$40.00</u> Enclosed X Authorized to be charged to deposit account</li> <li>8. Deposit account number: 50-0220</li> </ul>
DO NOT USE THIS SPACE	
<ul> <li>9. Statement and signature To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. Scott C. Hatfield, Reg. No. 38,176</li></ul>	
CERTIFICATION OF FACSIMILE TRANSMISSION UNDER 37 CFR § 1.8 I hereby certify that this correspondence is being facsimile transmitted to the U.S. Patent and Trademark Office via facsimile number 571-273-0140 on August 30, 2006.	

PATENT REEL: 018200 FRAME: 0191

NO. 2534 P. 3

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Attorney Docket No. 5649-1953

## ASSIGNMENT

THIS ASSIGNMENT, made by us, Scung-ok Jung, citizen of the Republic of Korea, residing at #33-1102 Dongah Apt., 70-124 Bupyeong-dong, Bupyeong-gu, Incheon Metropolitan City, Republic of Korea; and II-young Moon, citizen of the Republic of Korea, residing at #405-1702 Sunkyung Apt., Kkachi Maeul, Gumi-dong, Bundang-gu, Seongnam-si, Gyeonggi-do, Republic of Korea;

WITNESSETH: That,

WHEREAS, we are the joint inventors of certain new and useful improvements in INTEGRATED CIRCUIT DEVICES INCLUDING INSULATING SUPPORT LAYERS AND RELATED METHODS AND STRUCTURES, for which an application for United States Letters Patent has been filed, or is being filed concurrently, in the United States Patent and Trademark Office. We hereby authorize and request Myers Bigel Sibley & Sajovec, P.A., to insert here in parentheses (Application No. 11/476.459\_, filed June 28, 2006) the application number and the filing date of said application when known or to file this Assignment concurrently with the application; and

WHEREAS, Samsung Electronics Co., Ltd., a Korean corporation having a principal place of business at 416, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea, hereinafter referred to as assignee, is desirous of acquiring the entire right, title and interest in and to said invention as described in said application, and in and to any and all Letters Patent which shall be granted therefor in the United States of America and all foreign countries;

NOW, THEREFORE, To Whom It May Concern, be it known that for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we have sold and by these presents do hereby sell, assign, transfer, and convey unto the said assignee, its successors and assigns, the entire right, title, and interest in and to the said invention and application, and in and to any and all continuations, continuations-in-part, or divisions thereof, and in and to any and all Letters Patent of the United States of America and all foreign countries or reissues or other forms of protection thereof which may be granted therefor or thereon, for the full end of the term for which said Letters Patent may be granted along with any term extensions thereon or therefor, together with the right to claim the priority of said application in all foreign countries in accordance with the International Convention, the same to be held and enjoyed by said assignce, its successors and assigns, as fully and entirely as the same would have been held and enjoyed by us if this assignment and sale had not been made.

We hereby request that said Letters Patent be issued in accordance with this assignment.

We Author covenant and agree that, at the time of the execution and delivery of these presents, we possess full title to the invention and application above-mentioned, and that we have the unencumbered right and authority to make this assignment.

We further covenant and agree to promptly communicate to said assignce or its representatives any facts known to us relating to said invention, to testify in any interference or legal proceedings involving sold invention, to execute any additional papers which may be requested to confirm the right of the assignee, its representatives, successors, or assigns to secure patent or similar protection for the said invention in all countries and to vest in the assignee complete title to the said invention and Letters Patent, without further compensation, but at the expense of said assignce, its successors, assigns, and other legal representatives; and we hereby instruct, and further covenant and agree to bind our heirs, legal representatives, and assigns, to do same, without further compensation, but at the expense of said assignee or its representatives. IN WITNESS WHEREOF, we have hereunto set our hands and seals on this 20th day

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of August \_, 2006. Gung ok Jung (SEAL) Soung-ok Jung

Thyong Mion (SEAL)

Witnessed by:

Date:

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RECORDED: 08/30/2006 by GFI FAX maker fax server. For more information REEL: 018200 FRAME: 0193